

***8-Bit Bidirectional Voltage-Level Translator with
Auto Direction Sensing and $\pm 15\text{kV}$ ESD Protection***

UM3308/UM3308H CSP20 2.4×1.9

UM3308UK TSSOP20

UM3308QA QFN20 4.5×3.5

General Description

UM3308/UM3308H/UM3308UK/UM3308QA is an 8-channel bidirectional voltage level translator with auto direction sensing and $\pm 15\text{kV}$ ESD protection. This 8-channel non-inverting translator uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2V to 3.6V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.65V to 5.5V. This allows for universal low-voltage bidirectional translation between any of the 1.2V, 1.5V, 1.8V, 2.5V, 3.3V, and 5V voltage nodes. Both I/O ports are auto-sensing; thus, no direction pin is required, making it ideal for data transfer between low-voltage ASICs/PLDs and higher voltage systems.

The UM3308/UM3308H/UM3308UK/UM3308QA operates at a guaranteed data rate of 20Mbps over the entire specified operating voltage range. Within specific voltage domains, higher data rates are up to 100Mbps.

When the output-enable (OE) input is low, all outputs are placed in the high-impedance state. The UM3308/UM3308H is designed so that the OE input circuit is supplied by V_{CCA} .

To ensure the high-impedance state during power up or power down, OE should be tied to GND through a pull down resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The UM3308 and UM3308H are both available in CSP20 2.4×1.9 bump package while the UM3308H specially features in wafer backside coating process, making the chip more unbreakable. The UM3308UK is available in TSSOP20 package and the UM3308QA is available in QFN20 4.5×3.5 package.

Applications

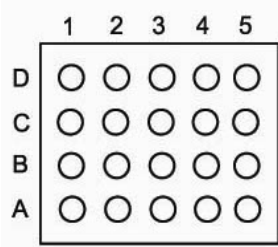
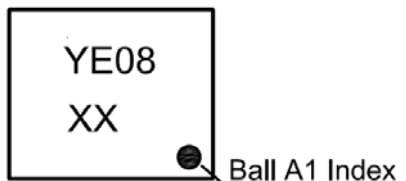
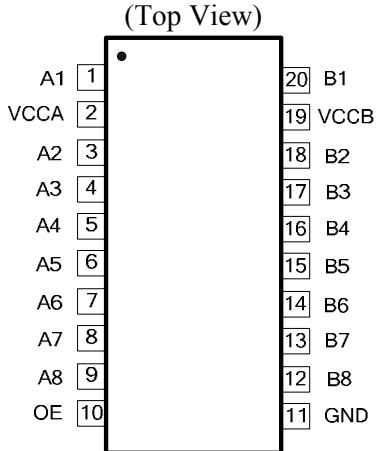
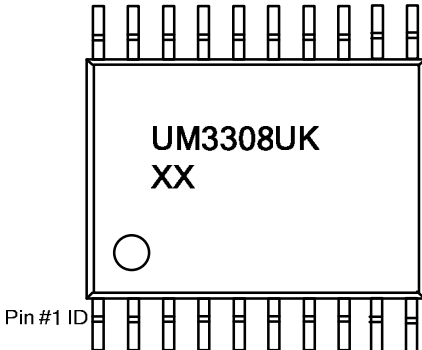
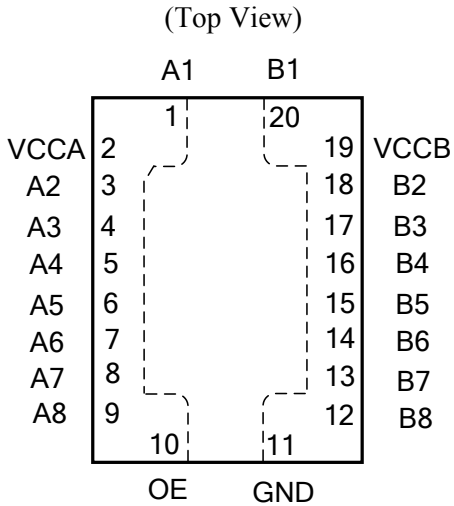
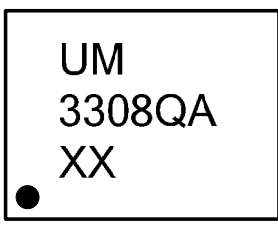
- Low-Voltage ASIC Level Translation
- Cell-Phone Cradles
- Portable POS Systems
- Portable Communication Devices
- Low-Cost Serial Interfaces
- Cell-Phones
- GPS
- Telecommunications Equipment

Features

- 1.2V to 3.6V on A Port and 1.65V to 5.5V on B Port ($V_{CCA} \leq V_{CCB}$)
- V_{CC} Isolation Feature – If Either V_{CC} Input is at GND, All Outputs are in the High-Impedance State
- OE Input Circuit Referenced to V_{CCA}
- Low Power Consumption
- Latch-Up Performance Exceeds 100mA
- $\pm 15\text{kV}$ ESD Protection on B Ports

Pin Configurations

Top View

<p>(Bottom View)</p> 	 <p>XX: Week Code UM3308/UM3308H CSP20 2.4×1.9</p>
<p>(Top View)</p> 	 <p>XX: Week Code UM3308UK TSSOP20</p>
<p>(Top View)</p> 	 <p>XX: Week Code UM3308QA QFN20 4.5×3.5</p>

Ball Mapping for UM3308/UM3308H

	5	4	3	2	1
D	B8	B6	B4	B2	V _{CCB}
C	GND	B7	B5	B3	B1
B	OE	A7	A5	A3	A1
A	A8	A6	A4	A2	V _{CCA}

Transparent Top View

Pin Description

Pin Name	Function
A1	Input/Output 1. Referenced to V _{CCA}
V _{CCA}	A-Port Supply Voltage. $1.1V \leq V_{CCA} \leq 3.6V$ and $V_{CCA} \leq V_{CCB}$
A2	Input/Output 2. Referenced to V _{CCA}
A3	Input/Output 3. Referenced to V _{CCA}
A4	Input/Output 4. Referenced to V _{CCA}
A5	Input/Output 5. Referenced to V _{CCA}
A6	Input/Output 6. Referenced to V _{CCA}
A7	Input/Output 7. Referenced to V _{CCA}
A8	Input/Output 8. Referenced to V _{CCA}
OE	3-State Output Enable. Pull OE low to place all outputs in 3-state mode. Referenced to V _{CCA}
GND	Ground
B8	Input/Output 8. Referenced to V _{CCB}
B7	Input/Output 7. Referenced to V _{CCB}
B6	Input/Output 6. Referenced to V _{CCB}
B5	Input/Output 5. Referenced to V _{CCB}
B4	Input/Output 4. Referenced to V _{CCB}
B3	Input/Output 3. Referenced to V _{CCB}
B2	Input/Output 2. Referenced to V _{CCB}
V _{CCB}	B-Port Supply Voltage. $1.65V \leq V_{CCB} \leq 5.5V$
B1	Input/Output 1. Referenced to V _{CCB}

Ordering Information

Part Number	Packaging Type	Marking Code	Shipping Qty
UM3308	CSP20 2.4×1.9	YE08	3000pcs/7Inch Tape & Reel
UM3308H			
UM3308UK	TSSOP20	UM3308UK	3000pcs/13Inch Tape & Reel
UM3308QA	QFN20 4.5×3.5	UM3308QA	3000pcs/13Inch Tape & Reel

Absolute Maximum Ratings (Note 1)

Over operating free-air temperature range (unless otherwise noted)

Symbol	Parameter		Value	Unit
V_{CCA}	Supply Voltage Range		-0.5 to +4.5	V
V_{CCB}	Supply Voltage Range		-0.5 to +6.5	V
V_I	Input Voltage Range (Note 2)	A ports	-0.5 to +4.5	V
		B ports	-0.5 to +6.5	
V_O	Voltage Range Applied to Any Output in the High-Impedance or Power-Off State (Note 2)	A ports	-0.5 to +4.5	V
		B ports	-0.5 to +6.5	
V_O	Voltage Range Applied to Any Output in the High or Low State (Note 2, 3)	A ports	-0.5 to ($V_{CCA}+0.5$)	V
		B ports	-0.5 to ($V_{CCB}+0.5$)	
I_{IK}	Input Clamp Current	$V_I < 0$	-50	mA
I_{OK}	Output Clamp Current	$V_O < 0$	-50	mA
I_O	Continuous Output Current		± 50	mA
	Continuous Current through V_{CCA} , V_{CCB} , or GND		± 100	
θ_{JA}	Package Thermal Impedance		78	$^{\circ}\text{C/W}$
T_{OP}	Operating Temperature Range		-40 to +85	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range		-65 to +150	$^{\circ}\text{C}$

Note 1: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Note 2: The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

Note 3: The value of V_{CCA} and V_{CCB} are provided in the recommended operating conditions table.

Recommended Operating Conditions (Note 1, 2)

Symbol	Parameter		V_{CCA}	V_{CCB}	Min	Max	Unit
V_{CCA}	Supply Voltage				1.2	3.6	V
					1.65	5.5	
V_{CCB}	Supply Voltage				$V_{CCI} \times 0.65$ (Note3)	V_{CCI}	V
					$V_{CCA} \times 0.65$	5.5	
V_{IH}	High Level Input Voltage	Data Inputs	1.2V to 3.6V	1.65V to 5.5V	$V_{CCI} \times 0.65$ (Note3)	V_{CCI}	V
		OE	1.2V to 3.6V	1.65V to 5.5V	$V_{CCA} \times 0.65$	5.5	
V_{IL}	Low Level Input Voltage	Data Inputs	1.2V to 5.5V	1.65V to 5.5V	0	$V_{CCI} \times 0.35$	V
		OE	1.2V to 3.6V	1.65V to 5.5V	0	$V_{CCA} \times 0.35$	
$\Delta t/\Delta V$	Input Transition Rise or Fall Time	A-Port Inputs	1.2V to 3.6V	1.65V to 5.5V		40	ns/V
		B-Port Inputs	1.2V to 3.6V	1.65V to 3.6V		40	
				4.5V to 5.5V		30	

Note 1: The A and B sides of an unused data I/O pair must be held in the same state, i.e., both at V_{CCI} or both at GND.

Note 2: V_{CCA} must be less than or equal to V_{CCB} and must not exceed 3.6 V.

Note 3: V_{CCI} is the supply voltage associated with the input port.

Electrical Characteristics (Note 1, 2)

Over recommended operating free-air temperature range (unless otherwise noted)

Parameter	Test Conditions	V _{CCA}	V _{CCB}	T _A =25°C		-40°C to 85°C		Unit
				Typ	Max	Min	Max	
V _{OHA}	I _{OH} =-20μA	1.2V		1.1				V
		1.4V to 3.6V				V _{CCA} -0.4		
V _{OLA}	I _{OL} =20μA	1.2V		0.3				V
		1.4V to 3.6V				0.4		
V _{OHB}	I _{OH} =-20μA		1.65V to 5.5V			V _{CCB} -0.4		V
V _{OLB}	I _{OL} =20μA		1.65V to 5.5V			0.4		V
I _I	OE	1.2V to 3.6V	1.65V to 5.5V	±1		±2		μA
I _{off}	A Port	0V	0V to 5.5V	±1		±2		μA
	B Port	0V to 3.6V	0V	±1		±2		
I _{OZ}	A or B Port	OE=GND	1.2V to 3.6V	1.65V to 5.5V	±1		±2	μA
I _{CCA}	V _I =V _{CCI} or GND I _O =0	1.2V	1.65V to 5.5V	0.06				μA
		1.4V to 3.6V	1.65V to 5.5V			5		
		3.6V	0V			2		
		0V	5.5V			-2		
I _{CCB}	V _I =V _{CCI} or GND I _O =0	1.2V	1.65V to 5.5V	3.5				μA
		1.4V to 3.6V	1.65V to 5.5V			5		
		3.6V	0V			-2		
		0V	5.5V			2		
I _{CCA} +I _{CCB}	V _I =V _{CCI} or GND I _O =0	1.2V	1.65V to 5.5V	3.5				μA
		1.4V to 3.6V	1.65V to 5.5V			10		
I _{CCZA}	V _I =V _{CCI} or GND I _O =0, OE=GND	1.2V	1.65V to 5.5V	0.05				μA
		1.4V to 3.6V	1.65V to 5.5V			5		
I _{CCZB}	V _I =V _{CCI} or GND I _O =0, OE=GND	1.2V	1.65V to 5.5V	3.5				μA
		1.4V to 3.6V	1.65V to 5.5V			5		
C _i	OE	1.2V to 3.6V	1.65V to 5.5V	5		5.5		pF
C _{io}	A Port	1.2V to 3.6V	1.65V to 5.5V	5		6.5		pF
	B Port			8		10		

 Note 1: V_{CCI} is the supply voltage associated with the input port.

 Note 2: V_{CCO} is the supply voltage associated with the output port.

Switching Characteristics
 $T_A = +25^\circ\text{C}$, $V_{CCA} = 1.2\text{V}$

Parameter	From (Input)	To (Output)	$V_{CCB}=1.8\text{V}$	$V_{CCB}=2.5\text{V}$	$V_{CCB}=3.3\text{V}$	$V_{CCB}=5\text{V}$	Unit
			Typ	Typ	Typ	Typ	
t_{pd}	A	B	7	6	5.3	5.5	ns
	B	A	7.5	6.5	6	6	
t_{en}	OE	A	1	1	1	1	μs
		B	1	1	1	1	
t_{dis}	OE	A	18	16	14	14	ns
		B	19	17	15	15	
t_{rA}, t_{fA}	A Port Rise and Fall Time		5	5	5	5	ns
t_{rB}, t_{fB}	B Port Rise and Fall Time		2.5	1.5	1.2	1	ns
$t_{SK(O)}$	Channel-to-Channel		0.5	0.5	0.5	1.5	ns
Max Data Rate			20	20	20	20	Mbps

Switching Characteristics

 Over recommended operating free-air temperature range, $V_{CCA}=1.5\text{V}\pm 0.1\text{V}$ (unless otherwise noted)

Parameter	From (Input)	To (Output)	$V_{CCB}=1.8\text{V} \pm 0.15\text{V}$		$V_{CCB}=2.5\text{V} \pm 0.2\text{V}$		$V_{CCB}=3.3\text{V} \pm 0.3\text{V}$		$V_{CCB}=5\text{V} \pm 0.5\text{V}$		Unit
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{pd}	A	B	2	15	1.2	11	1.1	10	1	10	ns
	B	A	1	15	0.9	12	0.5	12	0.3	13	
t_{en}	OE	A		1		1		1		1	μs
		B		1		1		1		1	
t_{dis}	OE	A	6	30	5.5	28	5.5	25	5.5	23	ns
		B	5.5	30	5	25	5	20	5	20	
t_{rA}, t_{fA}	A Port Rise and Fall Time		1.5	5.0	1.5	5.0	1.5	5.0	1.5	5.0	ns
t_{rB}, t_{fB}	B Port Rise and Fall Time		0.9	4.5	0.6	3.5	0.5	3	0.4	2.5	ns
$t_{SK(O)}$	Channel-to-Channel			0.5		0.5		0.5		0.5	ns
Max Data Rate			40		40		40		40		Mbps

Switching Characteristics

Over recommended operating free-air temperature range, $V_{CCA}=1.8V\pm 0.15V$ (unless otherwise noted)

Parameter	From (Input)	To (Output)	$V_{CCB}=1.8V \pm 0.15V$		$V_{CCB}=2.5V \pm 0.2V$		$V_{CCB}=3.3V \pm 0.3V$		$V_{CCB}=5V \pm 0.5V$		Unit
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{pd}	A	B	1.6	10	1.4	9	1.3	7	1.2	6.5	ns
	B	A	1.5	12	1.3	8.5	1	8	0.9	8	
t_{en}	OE	A		1		1		1		1	μs
		B		1		1		1		1	
t_{dis}	OE	A	6	34	5.5	23	5	20	5	17.6	ns
		B	5.5	33	4.5	22	4.2	16.8	4.4	16.3	
t_{rA}, t_{fA}	A Port Rise and Fall Time		1	4.2	1.1	4.0	1.1	4.0	1.1	4.0	ns
t_{rB}, t_{fB}	B Port Rise and Fall Time		0.9	4	0.6	3.2	0.5	2.8	0.4	2.8	ns
$t_{SK(O)}$	Channel-to-Channel			0.5		0.5		0.5		0.5	ns
Max Data Rate			60		60		60		60		Mbps

Switching Characteristics

Over recommended operating free-air temperature range, $V_{CCA}=2.5V\pm 0.2V$ (unless otherwise noted)

Parameter	From (Input)	To (Output)	$V_{CCB}=2.5V \pm 0.2V$		$V_{CCB}=3.3V \pm 0.3V$		$V_{CCB}=5V \pm 0.5V$		Unit
			Min	Max	Min	Max	Min	Max	
t_{pd}	A	B	1.1	6.5	1	5.2	0.9	5	ns
	B	A	1.2	6.6	1.1	5.1	0.9	4.4	
t_{en}	OE	A		1		1		1	μs
		B		1		1		1	
t_{dis}	OE	A	5.0	23	4.6	15.2	4.6	13	ns
		B	4.4	22	3.8	16	3.9	13.3	
t_{rA}, t_{fA}	A Port Rise and Fall Time		0.8	3	0.8	3	0.8	3	ns
t_{rB}, t_{fB}	B Port Rise and Fall Time		0.7	2.7	0.5	2.8	0.4	2.7	ns
$t_{SK(O)}$	Channel-to-Channel			0.5		0.5		0.5	ns
Max Data Rate			100		100		100		Mbps

Switching Characteristics

Over recommended operating free-air temperature range, $V_{CCA}=3.3V\pm 0.3V$ (unless otherwise noted)

Parameter	From (Input)	To (Output)	$V_{CCB}=3.3V \pm 0.3V$		$V_{CCB}=5V \pm 0.5V$		Unit
			Min	Max	Min	Max	
t_{pd}	A	B	0.9	5	0.8	4	ns
	B	A	1	5.1	0.9	4	
t_{en}	OE	A		1		1	μs
		B		1		1	
t_{dis}	OE	A	5	15	4	13	ns
		B	4	16	3.4	13.8	
t_{rA}, t_{fA}	A Port Rise and Fall Time		0.7	2.5	0.7	2.5	ns
t_{rB}, t_{fB}	B Port Rise and Fall Time		0.5	2.1	0.4	2.8	ns
$t_{SK(O)}$	Channel-to-Channel			0.5		0.5	ns
Max Data Rate			100		100		Mbps

Applications Information

UM3308/UM3308H/UM3308UK/UM3308QA ESD protected level translator provides level shifting necessary to allow data transfer in a multi-voltage system. Externally applied voltages, V_{CCA} and V_{CCB} set the logic levels on either side of device. A low voltage signal present on V_{CCA} side of the device appears as a high voltage logic signal on the V_{CCB} side of the device, and vice-versa.

Block Diagram

The UM3308/UM3308H/UM3308UK/UM3308QA (block diagram see Figure 1) does not require a direction-control signal to control the direction of data flow from A to B or from B to A. In a dc state, the output drivers of the UM3308/UM3308H/UM3308UK/UM3308QA can maintain a high or low, but are designed to be weak, so that they can be overdriven by an external driver when data on the bus starts flowing to the opposite direction.

The output one shot detects rising or falling edges on the A or B ports. During a rising edge, the one shot turns on the PMOS transistors (T1, T3) for a short duration, which speeds up the low-to-high transition. Similarly, during a falling edge, the one shot turns on the NMOS transistors (T2, T4) for a short duration, which speeds up the high-to-low transition.

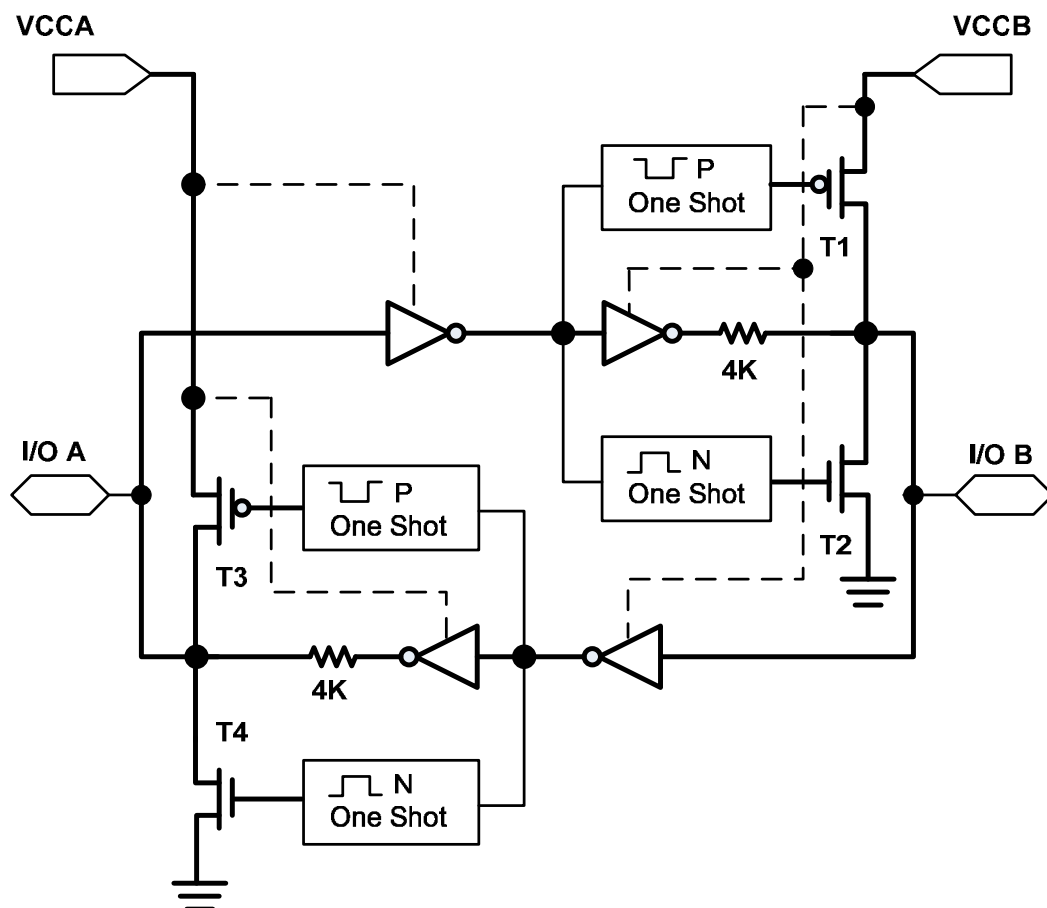
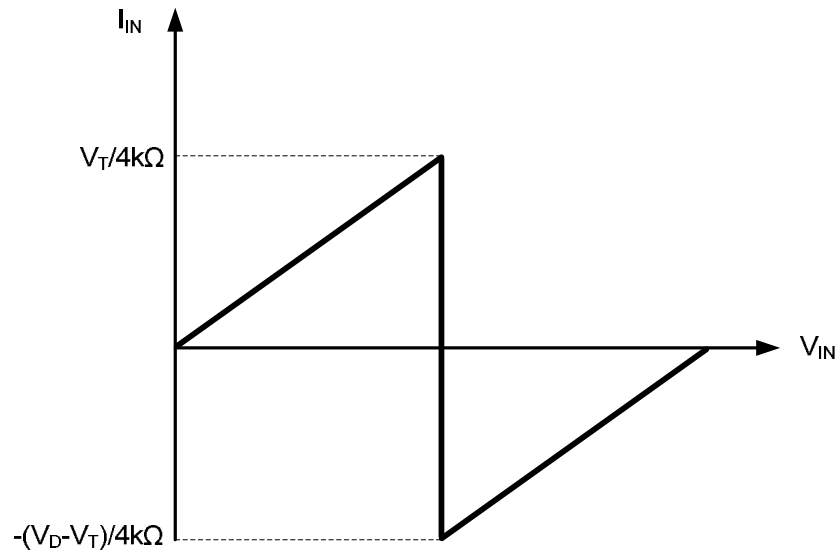


Figure 1 Block Diagram of UM3308/UM3308H/UM3308UK/UM3308QA I/O Cell

Input Driver Requirements

Typical I_{IN} vs V_{IN} characteristics of the UM3308/UM3308H/UM3308UK/UM3308QA are shown in Figure 2. For proper operation, the device driving the data I/Os of the UM3308/UM3308H/UM3308UK/UM3308QA must have drive strength of at least $\pm 2\text{mA}$.



- A: V_T is the input threshold voltage of the UM3308/UM3308H/UM3308UK/UM3308QA (typical $V_{CC1}/2$).
 B: V_D is the supply voltage of the external driver.

Figure 2 Typical I_{IN} vs. V_{IN} Curve

Power Up

During operation, ensure that $V_{CCA} \leq V_{CCB}$ at all times. During power-up sequencing, $V_{CCA} \geq V_{CCB}$ does not damage the device, so any power supply can be ramped up first. The UM3308/UM3308H/UM3308UK/UM3308QA has circuitry that disables all output ports when either V_{CC} is switched off ($V_{CCA/B} = 0\text{ V}$).

Enable and Disable

The UM3308/UM3308H/UM3308UK/UM3308QA has an OE input that is used to disable the device by setting OE=low, which places all I/Os in the high-impedance (Hi-Z) state. The disable time (t_{dis}) indicates the delay between when OE goes low and when the outputs actually get disabled (Hi-Z). The enable time (t_{en}) indicates the amount of time the user must allow for the one-shot circuitry to become operational after OE is taken high.

Pull-up or Pull-down Resistors on I/O Lines

The UM3308/UM3308H/UM3308UK/UM3308QA is designed to drive capacitive loads of up to 50pF. The output drivers of the UM3308/UM3308H/UM3308UK/UM3308QA have low dc drive strength. If pull-up or pull-down resistors are connected externally to the data I/Os, their values must be kept higher than 50kΩ to ensure that they do not contend with the output drivers of the UM3308/UM3308H/UM3308UK/UM3308QA.

For the same reason, the UM3308/UM3308H should not be used in applications such as I²C or 1-Wire where an open-drain driver is connected on the bidirectional data I/O.

Typical Operating Circuit

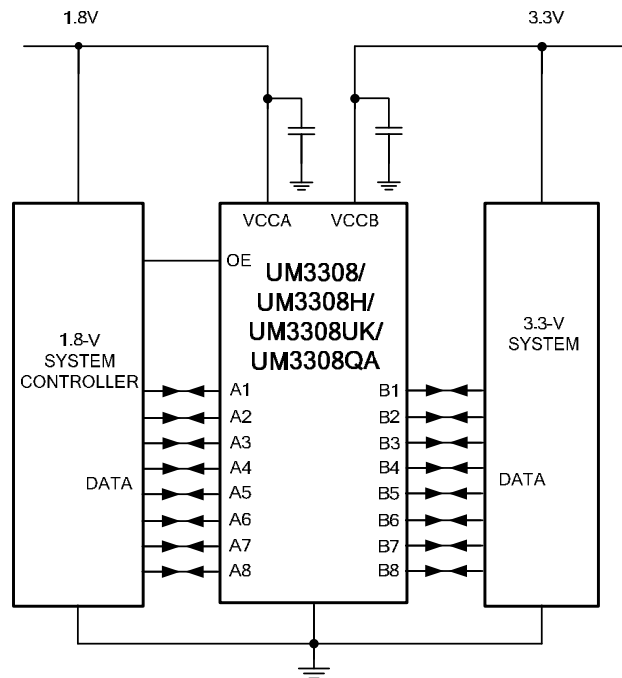
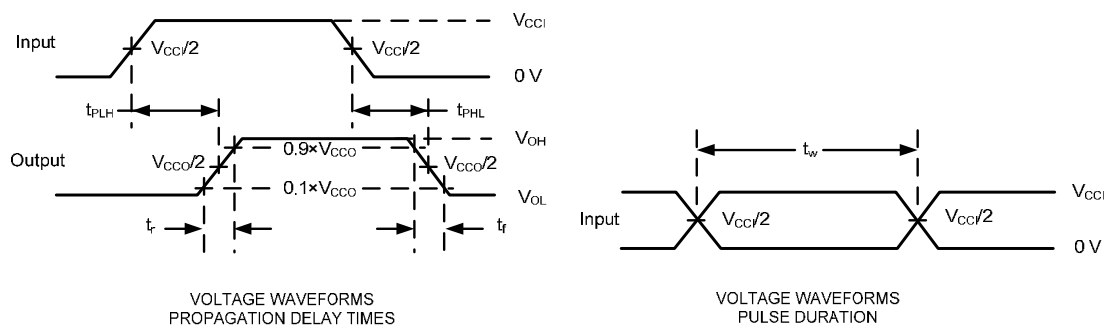
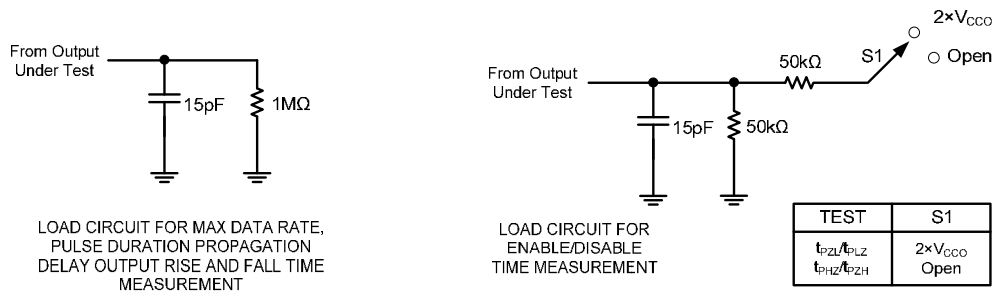


Figure 3 Typical Operating Circuit

Test Circuits



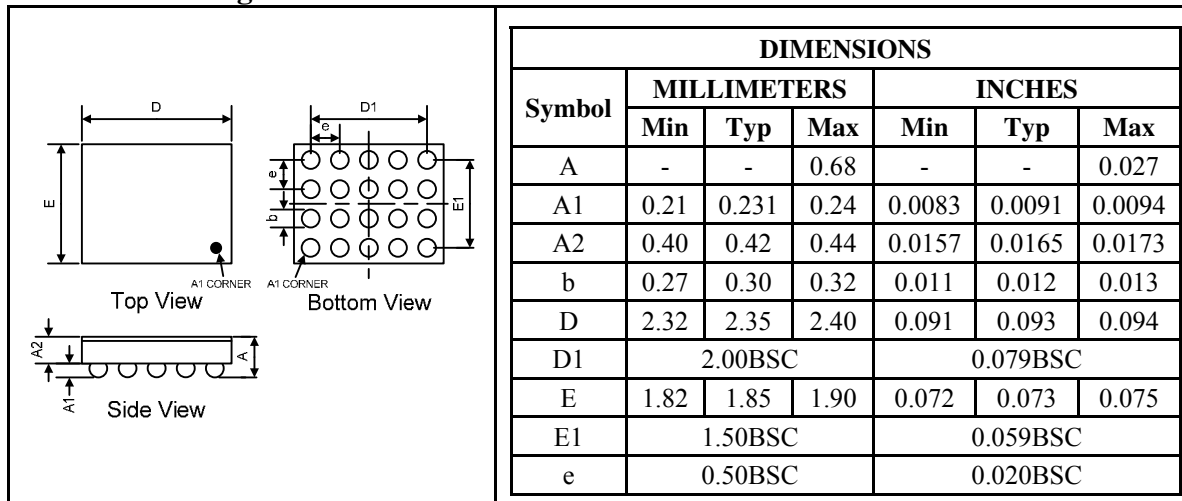
- A. C_L includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{MHz}$, $Z_o = 50\Omega$, $dv/dt \geq 1\text{V/ns}$.
- C. The outputs are measured one at a time, with one transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as t_{pd} .
- E. V_{CCi} is the V_{CC} associated with the input port.
- F. V_{CCO} is the V_{CC} associated with the output port.
- G. All parameters and waveforms are not applicable to all devices.

Figure 4 Load Circuits and Voltage Waveforms

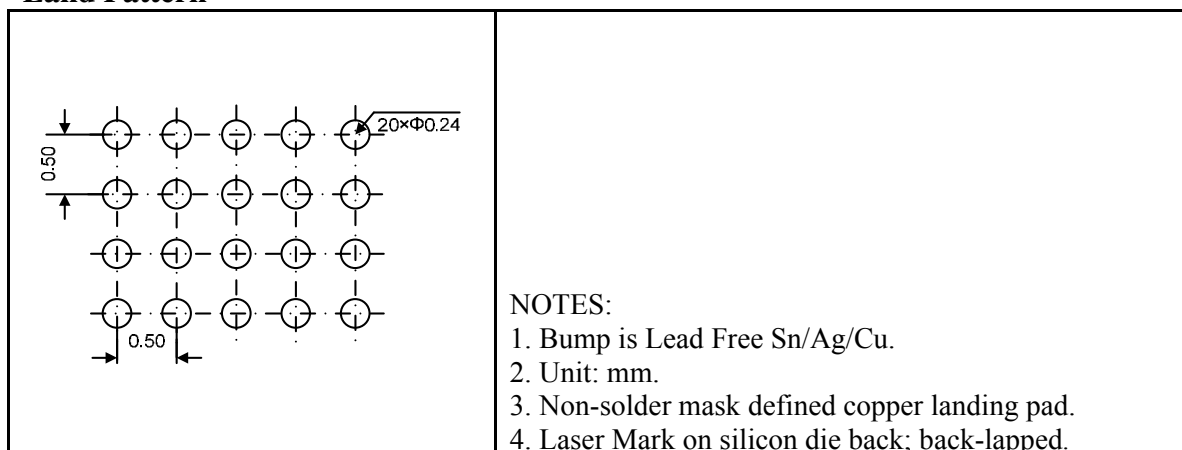
Package Information

UM3308/UM3308H: CSP20 2.4×1.9

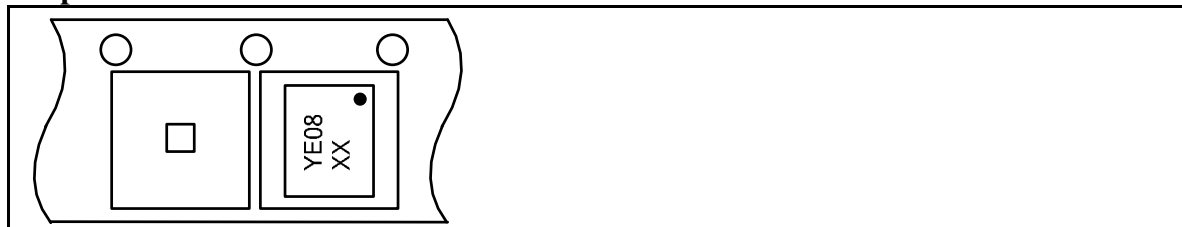
Outline Drawing



Land Pattern

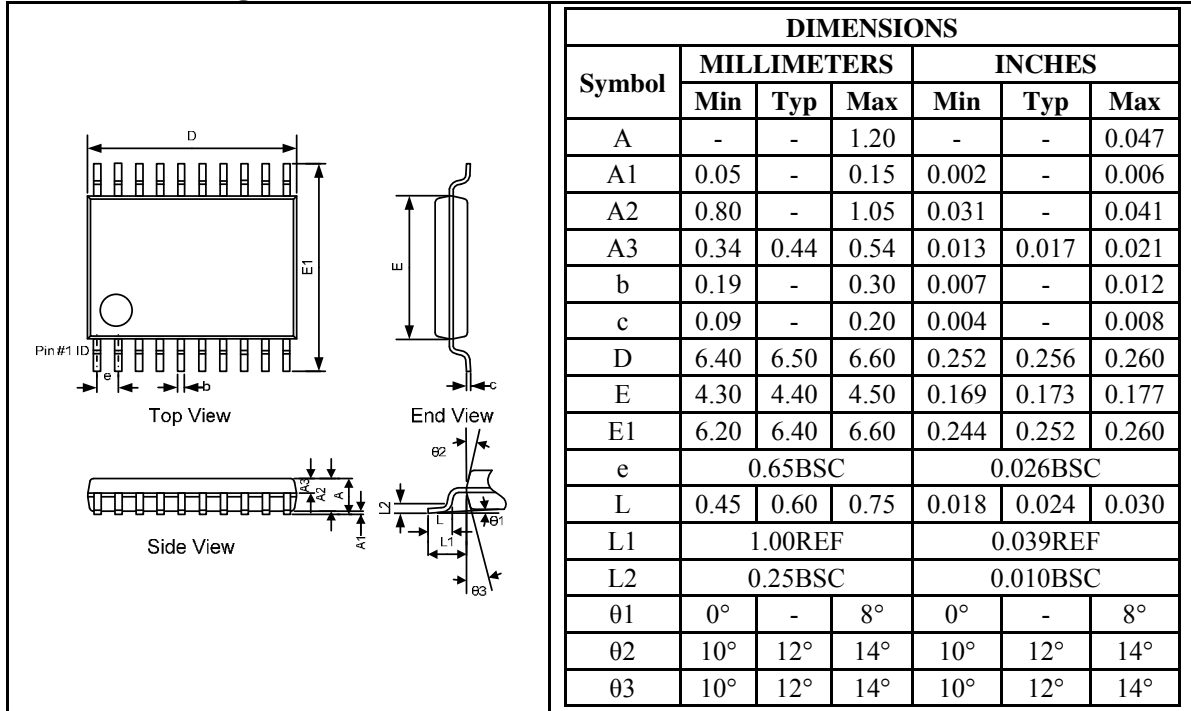


Tape and Reel Orientation

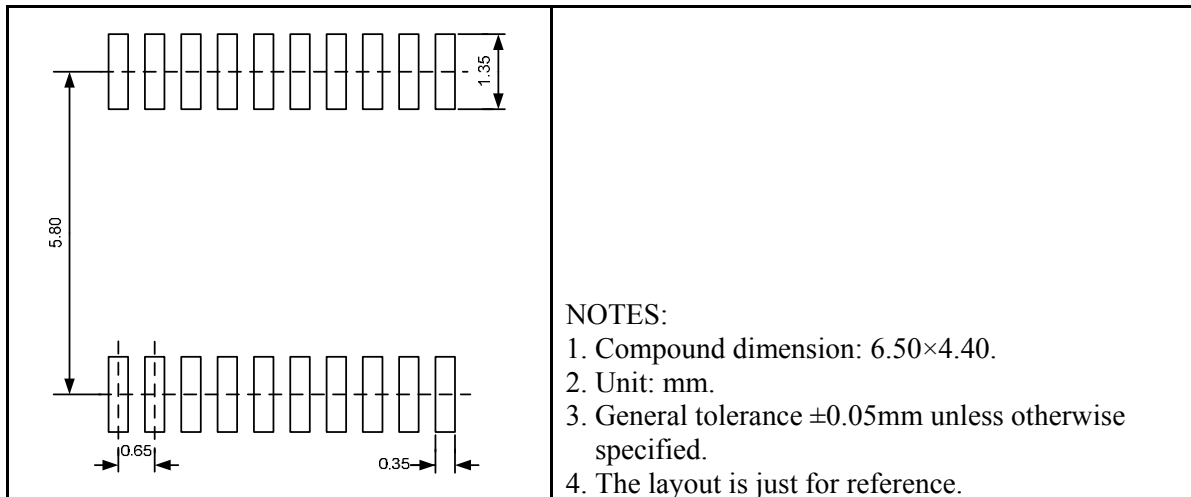


UM3308UK TSSOP20

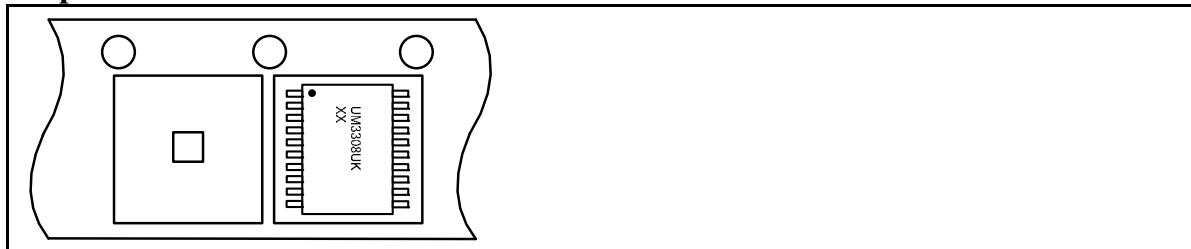
Outline Drawing



Land Pattern



Tape and Reel Orientation

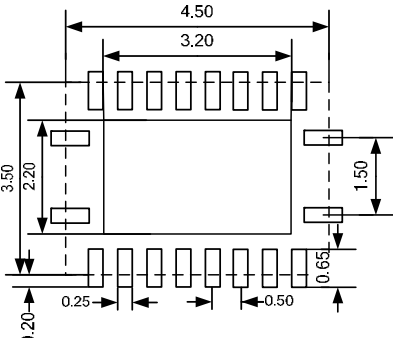


UM3308QA QFN20 4.5×3.5

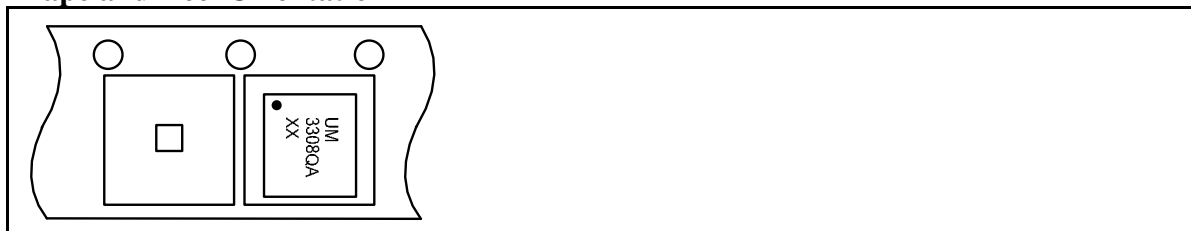
Outline Drawing

DIMENSIONS						
Symbol	MILLIMETERS			INCHES		
	Min	Typ	Max	Min	Typ	Max
A	0.70	0.75	0.80	0.028	0.030	0.032
A1	-	0.01	0.05	-	0.0004	0.002
A3	0.18	0.20	0.25	0.007	0.008	0.010
b	0.18	0.25	0.30	0.007	0.010	0.012
D	4.40	4.50	4.60	0.176	0.180	0.184
D2	3.10	3.20	3.30	0.124	0.128	0.132
D3	3.85REF			0.154REF		
E	3.40	3.50	3.60	0.136	0.140	0.144
E2	2.10	2.20	2.30	0.084	0.088	0.092
E3	0.35REF			0.014REF		
E4	0.75REF			0.030REF		
e	0.50BSC			0.020BSC		
e1	0.75BSC			0.030BSC		
L	0.35	0.40	0.45	0.014	0.016	0.018

Land Pattern

	<p>NOTES:</p> <ol style="list-style-type: none"> 1. Compound dimension: 4.50×3.50; 2. Unit: mm; 3. General tolerance ±0.05mm unless otherwise specified; 4. The layout is just for reference.
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Tape and Reel Orientation



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